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Vol. 15, No. 3

Serving IEEE Members of South Central Wisconsin

March 2012

Reverse Electrowetting: A new approach to high-power harvesting of mechanical energy

Date:	Thursday, March 15, 2012 WISCONSIN Map
Time:	6:00pm - 7:00pm
Speaker:	Tom Krupenkin, Professor Mechanical Engineering
Agenda:	Informal networking will begin at 5:30pm.
0	Presentation will begin at 6:00pm.
Location:	1610 Engineering Hall, UW-Madison College of Engineering
	Take North Randall Street to Engineering Drive to Parking Lot 17
Menu:	Meal provided: \$5 for IEEE members, \$10 for non-members, free for students.
RSVP:	Deadline: March 12. Go to https://meetings.vtools.ieee.org/meeting_view/list_meeting/11249
	to register. Please send questions or difficulties to Mark Vincent at mvincent@ecw.org.

Non-member quests are always welcome!

Abstract

Over the last decade electrical batteries have emerged as a critical bottleneck in portable electronics development. High-power mechanical energy harvesting can potentially provide a valuable alternative to the use of batteries, but until now, its adoption has been hampered by the lack of an efficient mechanical-to-electrical energy conversion technology. In this talk a novel mechanical-to-electrical energy conversion method is discussed. This method is uniquely suited for high-power energy harvesting from a wide variety of previously inaccessible environmental mechanical energy sources, including human locomotion. The method is based on reverse electrowetting (REWOD) - a novel microfluidic phenomenon. Electrical energy generation is achieved through the interaction of arrays of moving microscopic liquid droplets with novel nanometer-thick multilayer dielectric films.

Biography

Tom Krupenkin is Associate Professor, Nanotechnology Cluster and Mechanical Engineering, University of Wisconsin-Madison, Madison, Wisconsin, He received a Ph.D. in materials science from Moscow Institute for Physics and Engineering, Moscow, Russia in 1992, and a Ph.D in physics from Case Western Reserve University, Cleveland, Ohio in 1996. He holds over 50 US and international patents and has authored over 35 publications. His current research is focused on physics and chemistry of nanostructured surfaces, NEMS/MEMS devices, and physics of liquid-solid interfaces. He has received numerous professional awards and distinctions including the American Chemical Society Industrial Innovation Award (2007) for his work on tunable nanostructured surfaces; the Excellence in Research Award (2005) and the Energy Storage Enabling Technology of the Year Award (2006) for his work in Nanomembrane Battery; and the Emerging Technologies Award for his work in Microfluidics in Photonics (2003). His research has consistently attracted substantial media attention including pieces in New York Times. Scientific American, ABC News, Nature Materials, Physics Today, Science News, and New Scientist.

IEEE Entrepreneurs & Consultants Network, Madison Networking Meeting

	Thursday, April 5, 2012	m	
Time:	12:00pm to 1:00pm	MATC Madison Area Technical College	
	e: Presentation, topic TBD.		
Locatior	n: Madison Area Technical C	ollege (MATC V	Vest Campus)
	302 S. Gammon Road (Ac	ross from West	Towne Mall)
	Madison, WI 53717 Tel	ephone: 608-24	5-6100
Parking:	 Open parking, so come ea 	arly to get a clos	er spot.
Process	: Members are encouraged	to make introdu	ctions, describe endeavors, and make request
	for: contacts in target con	panies, needs,	resources. Bring your elevator speech and rolodex!
RSVP:	Tim Chapman (PrettyGoo	dGUIs@TrueNy	<u>m.NET</u>)





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Image: No. 3 Serving IEEE Members of the servi	of South Central Wisconsin March 2012			
SECTION Meetings The third Thursday of JanMay and SepDec. is reserved for a meeting to provide recent research, developments, trends and/or innovations in one of our membership's technical areas.	NETWORKING Meetings The first Thursday of every other month is reserved for a meeting to provide networking opportunities for members who are consultants or entrepreneurs. Bring your elevator speech and rolodex!			
Section Meeting Schedule for 2012 (schedule subject to change)	Networking Meeting Schedule for 2012 (schedule subject to change)			
January 19, EU e-Freight Software Initiative	February 2, TBD			
February 16, Patent Law	April 5, TBD			
March 15, Reverse Electrowetting by Tom Krupenkin, at UW Engineering Hall	June 7, TBD			
April 27, Network Coding, Distinguished	August 2, TBD			
Lecture, by Abdelhak Zoubir, at Promega	October 4, TBD			
May 17, Electricity Nanogenerators by Jerry Meyerhoff, at Promega	December 6, TBD			
May 24, Annual Wind Farm Tour busses start/end at UW Engineering Hall				
June 21 , TBD				
September 20, TBD				
October 18, International Trademarks by Richard Abegglen, at Promega				
November 15, TBD				
December 20, TBD				



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Vol. 15, No. 3 March 2012 Serving IEEE Members of South Central Wisconsin Selection of Officers **IEEE Madison Section Sponsors** At the December monthly We thank the following sponsors for their support of the IEEE Madison meeting, the IEEE Madison Section conducted its annual officer elections EMC, Product Safety & Environmental Testing prior to the presentation: Since 1983 New 3-Day Format Keeping the same important concepts and material EMC by Your Design An EMC Practical Applications Seminar and Workshop with a free 45 min. individual product design evaluation on April 20. take home proprietary computer program, expanded chapter on filter design, signal integrity, and signal return currents on PCB's at no extra charge April 17-19, 2012 (Tues. - Thurs.) Hilton Hotel, Northbrook, IL We are offering a special \$300 discount if you register by March 27, 2012 Classes fill quickly so register early email cgorowski@dlsemc.com or call 847-537-6400

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IEEE Membership Level Upgrades

Those interested in upgrading their IEEE membership level should send their resumes or other information showing five years of significant performance in an IEEE-designated field to Charles J Gervasi (cj@cgervasi.com). Madison Section Board will attempt to find Senior IEEE members knowledgeable in the applicant's area of practice who may be able to provide references. You are invited to attend the informal networking portion of the monthly Section meetings (starting at 11:30am) to meet the Section Board members and discuss intentions.

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IEEE Madison Section Newsletter

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For more information, contact Mitch Bradt at 608-263-1085 or <u>bradt@wisc.edu</u>.

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